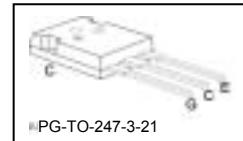
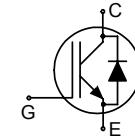




Low Loss DuoPack : IGBT in TrenchStop® and Fieldstop technology with anti-parallel diode

Features:

- 1.1V Forward voltage of antiparallel diode
- TrenchStop® and Fieldstop technology for 900 V applications offers :
 - very tight parameter distribution
 - high ruggedness, temperature stable behavior
 - easy parallel switching capability due to positive temperature coefficient in $V_{CE(sat)}$
- Low EMI
- Qualified according to JEDEC¹ for target applications
- Application specific optimisation of inverse diode
- Pb-free lead plating; RoHS compliant



Applications:

- Microwave Oven
- Soft Switching Applications for ZCS

Type	V_{CE}	I_c	$V_{CE(sat), T_j=25^\circ C}$	$T_{j,max}$	Marking	Package
IHW30N90T	900V	30A	1.5V	175°C	H30T90	PG-T0-247-3-21

Maximum Ratings

Parameter	Symbol	Value	Unit
Collector-emitter voltage	V_{CE}	900	V
DC collector current $T_C = 25^\circ C$ $T_C = 100^\circ C$	I_c	60 30	A
Pulsed collector current, t_p limited by $T_{j,max}$	I_{Cpuls}	900	
Turn off safe operating area $V_{CE} \leq 1200V$, $T_j \leq 150^\circ C$	-	90	
Diode forward current $T_C = 25^\circ C$ $T_C = 100^\circ C$	I_F	23 13	
Diode pulsed current, t_p limited by $T_{j,max}$	I_{Fpuls}	36	
Gate-emitter voltage	V_{GE}	± 20 ± 25	V
Transient Gate-emitter voltage ($t_p < 5$ ms)			
Power dissipation, $T_C = 25^\circ C$	P_{tot}	428	W
Operating junction temperature	T_j	-40...+175	°C
Storage temperature	T_{stg}	-55...+175	°C
Soldering temperature, 1.6mm (0.063 in.) from case for 10s	-	260	

¹ J-STD-020 and JESD-022

**Thermal Resistance**

Parameter	Symbol	Conditions	Max. Value	Unit
Characteristic				
IGBT thermal resistance, junction – case	R_{thJC}		0.35	K/W
Diode thermal resistance, junction – case	R_{thJCD}		1.1	
Thermal resistance, junction – ambient	R_{thJA}		40	

Electrical Characteristic, at $T_j = 25^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Conditions	Value			Unit
			min.	Typ.	max.	
Static Characteristic						
Collector-emitter breakdown voltage	$V_{(BR)CES}$	$V_{GE}=0\text{V}, I_C=500\mu\text{A}$	900	-	-	V
Collector-emitter saturation voltage	$V_{CE(\text{sat})}$	$V_{GE} = 15\text{V}, I_C=30\text{A}$ $T_j=25^\circ\text{C}$ $T_j=150^\circ\text{C}$ $T_j=175^\circ\text{C}$	-	1.5	1.7	
Diode forward voltage	V_F	$V_{GE}=0\text{V}, I_F=10\text{A}$ $T_j=25^\circ\text{C}$ $T_j=150^\circ\text{C}$ $T_j=175^\circ\text{C}$	-	1.1	1.3	
Gate-emitter threshold voltage	$V_{GE(\text{th})}$	$I_C=150\mu\text{A}, V_{CE}=V_{GE}$	4.6	5.3	6	
Zero gate voltage collector current	I_{CES}	$V_{CE}=900\text{V}, V_{GE}=0\text{V}$ $T_j=25^\circ\text{C}$ $T_j=150^\circ\text{C}$	-	-	250 2500	μA
Gate-emitter leakage current	I_{GES}	$V_{CE}=0\text{V}, V_{GE}=20\text{V}$	-	-	600	nA
Transconductance	g_{fs}	$V_{CE}=20\text{V}, I_C=20\text{A}$	-	26	-	S

Dynamic Characteristic

Input capacitance	C_{iss}	$V_{CE}=25\text{V},$	-	2617	-	pF
Output capacitance	C_{oss}	$V_{GE}=0\text{V},$	-	96	-	
Reverse transfer capacitance	C_{rss}	$f=1\text{MHz}$	-	38	-	
Gate charge	Q_{Gate}	$V_{CC}=720\text{V}, I_C=30\text{A}$ $V_{GE}=15\text{V}$	-	280	-	nC
Internal emitter inductance measured 5mm (0.197 in.) from case	L_E		-	13	-	nH

**Switching Characteristic, Inductive Load, at $T_j=25\text{ }^{\circ}\text{C}$**

Parameter	Symbol	Conditions	Value			Unit
			min.	Typ.	max.	
IGBT Characteristic						
Turn-on delay time	$t_{d(on)}$	$T_j=25\text{ }^{\circ}\text{C}, V_{CC}=600\text{V}, I_C=30\text{A}, V_{GE}=0/15\text{V}, R_G=15\Omega,$	-	45	-	ns
Rise time	t_r		-	26	-	
Turn-off delay time	$t_{d(off)}$		-	556	-	
Fall time	t_f		-	29	-	
Turn-on energy	E_{on}		-	-	-	mJ
Turn-off energy	E_{off}		-	1.8	-	
Total switching energy	E_{ts}		-	1.8	-	

Switching Characteristic, Inductive Load, at $T_j=175\text{ }^{\circ}\text{C}$

Parameter	Symbol	Conditions	Value			Unit
			min.	Typ.	max.	
IGBT Characteristic						
Turn-on delay time	$t_{d(on)}$	$T_j=175\text{ }^{\circ}\text{C}, V_{CC}=600\text{V}, I_C=30\text{A}, V_{GE}=0/15\text{V}, R_G=15\Omega$	-	44	-	ns
Rise time	t_r		-	38	-	
Turn-off delay time	$t_{d(off)}$		-	650	-	
Fall time	t_f		-	41	-	
Turn-on energy	E_{on}		-	-	-	mJ
Turn-off energy	E_{off}		-	2.4	-	
Total switching energy	E_{ts}		-	2.4	-	

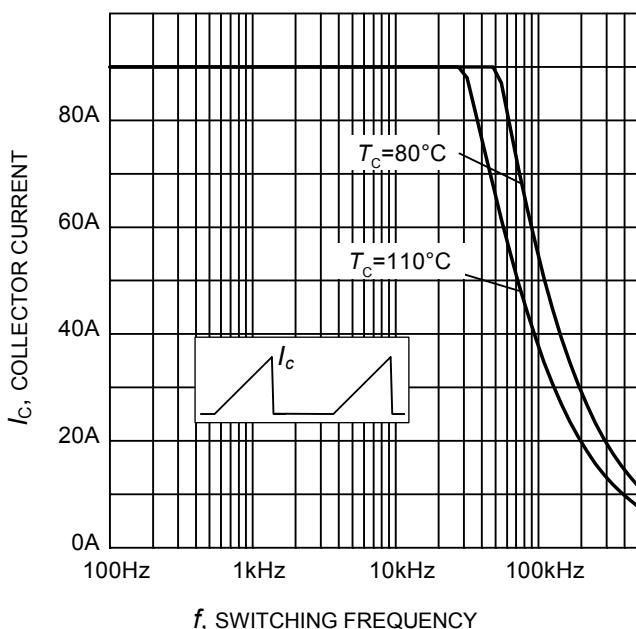


Figure 1. Collector current as a function of switching frequency for triangular current ($E_{on} = 0$, hard turn-off)
 $(T_j \leq 175^\circ\text{C}, D = 0.5, V_{CE} = 600\text{V}$,
 $V_{GE} = 0/+15\text{V}, R_G = 15\Omega)$

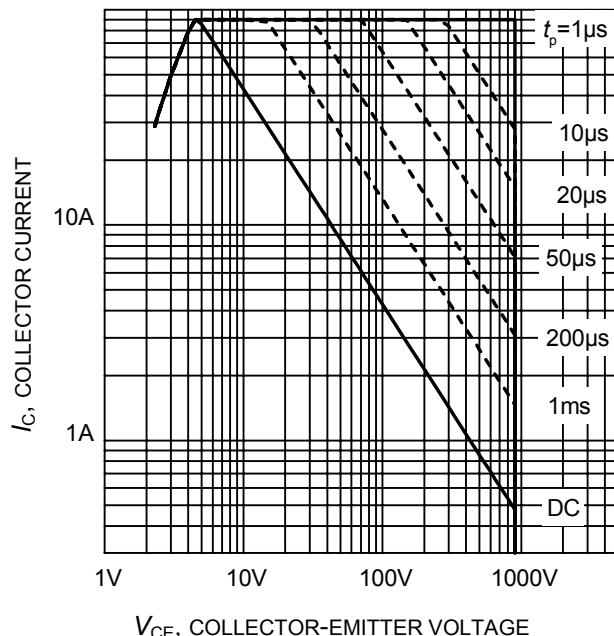


Figure 2. IGBT Safe operating area
 $(D = 0, T_C = 25^\circ\text{C}$,
 $T_j \leq 175^\circ\text{C}; V_{GE} = 15\text{V})$

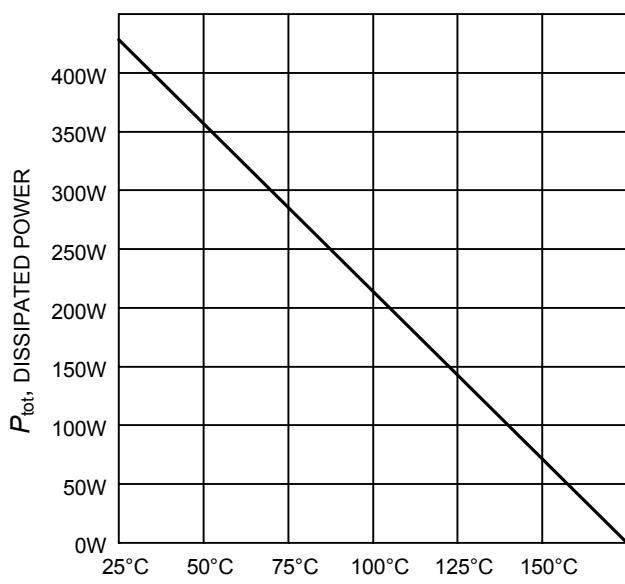


Figure 3. Power dissipation as a function of case temperature
 $(T_j \leq 175^\circ\text{C})$

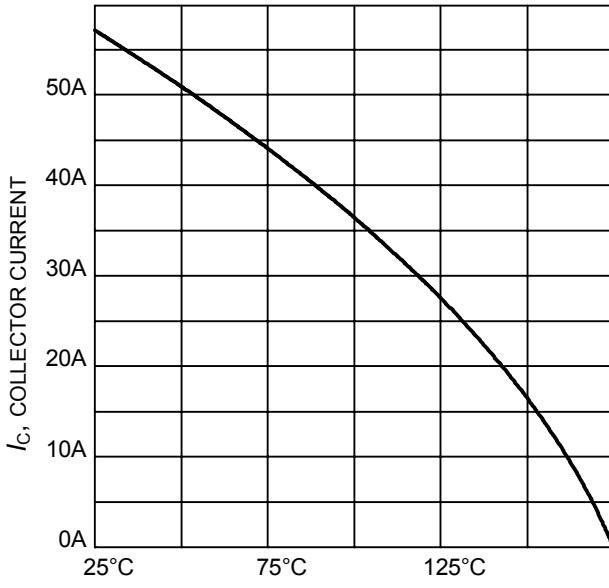
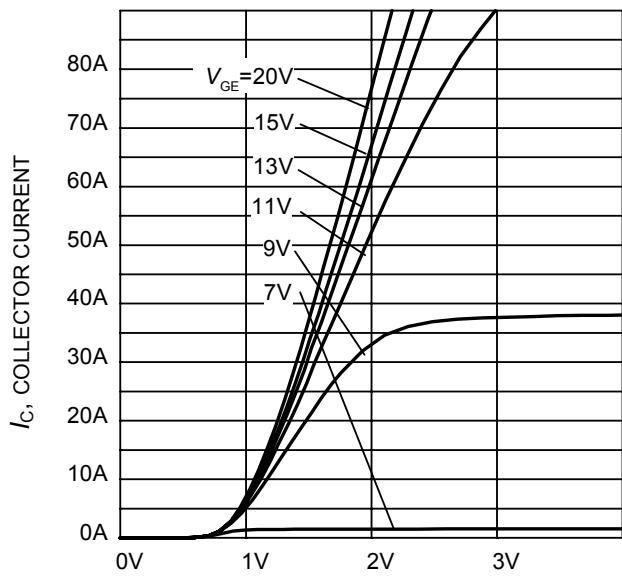
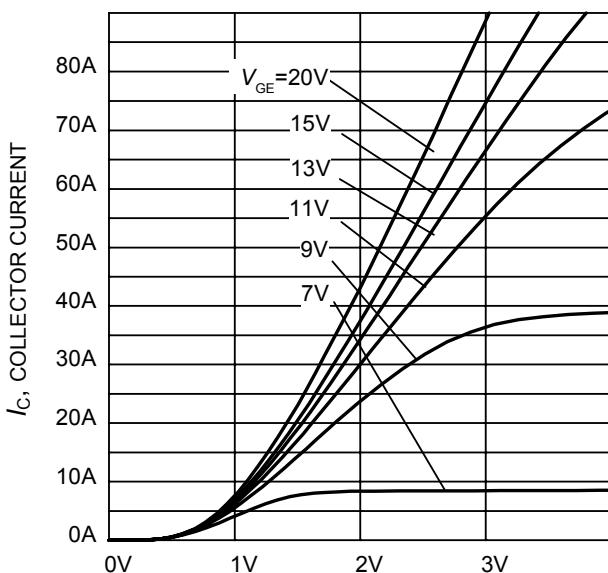
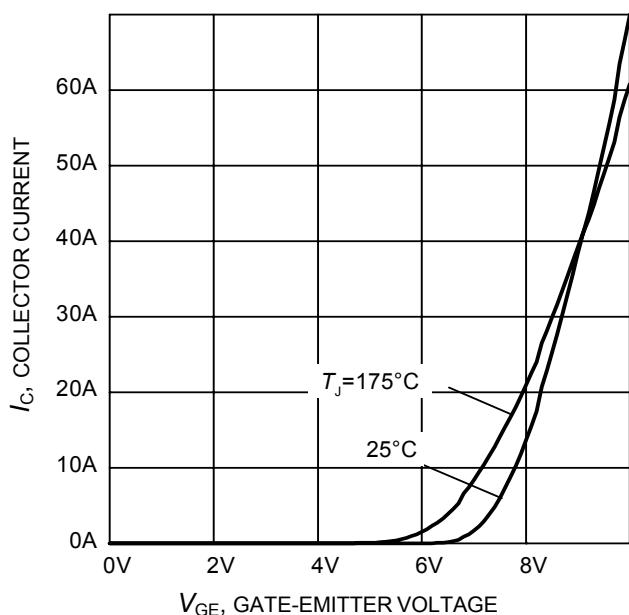
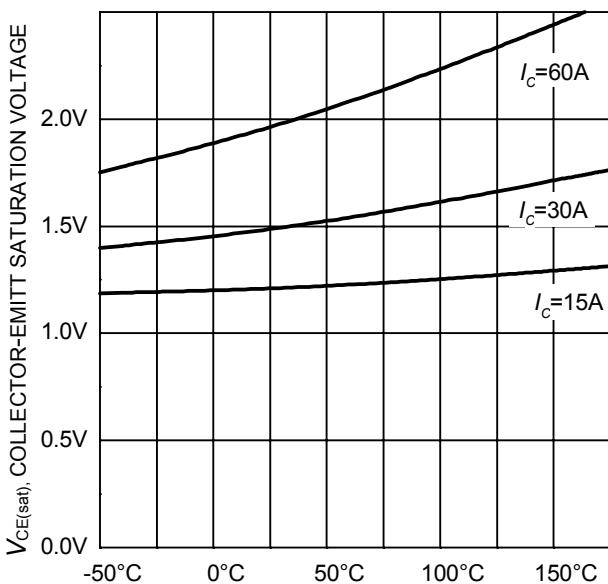


Figure 4. Collector current as a function of case temperature
 $(V_{GE} \geq 15\text{V}, T_j \leq 175^\circ\text{C})$

 V_{CE} , COLLECTOR-EMITTER VOLTAGE**Figure 5. Typical output characteristic**
($T_j = 25^\circ\text{C}$) V_{CE} , COLLECTOR-EMITTER VOLTAGE**Figure 6. Typical output characteristic**
($T_j = 175^\circ\text{C}$) V_{GE} , GATE-EMITTER VOLTAGE**Figure 7. Typical transfer characteristic**
($V_{CE}=20\text{V}$) T_j , JUNCTION TEMPERATURE**Figure 8. Typical collector-emitter saturation voltage as a function of junction temperature**
($V_{GE} = 15\text{V}$)

Soft Switching Series

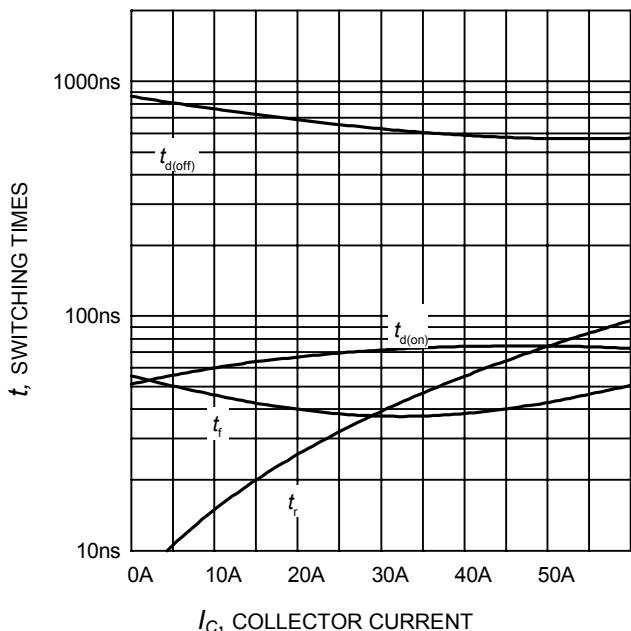


Figure 9. Typical switching times as a function of collector current
(inductive load, $T_J=175^\circ\text{C}$,
 $V_{CE}=600\text{V}$, $V_{GE}=0/15\text{V}$, $R_G=15\Omega$,
Dynamic test circuit in Figure E)

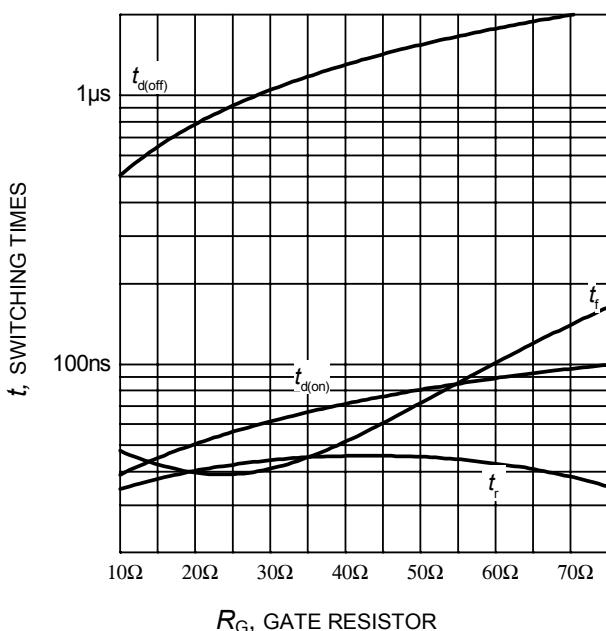


Figure 10. Typical switching times as a function of gate resistor
(inductive load, $T_J=175^\circ\text{C}$,
 $V_{CE}=600\text{V}$, $V_{GE}=0/15\text{V}$, $I_C=30\text{A}$,
Dynamic test circuit in Figure E)

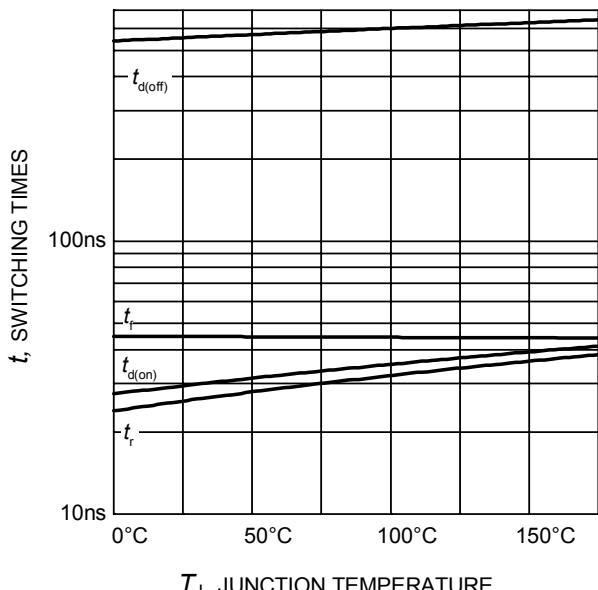


Figure 11. Typical switching times as a function of junction temperature
(inductive load, $V_{CE}=600\text{V}$,
 $V_{GE}=0/15\text{V}$, $I_C=30\text{A}$, $R_G=15\Omega$,
Dynamic test circuit in Figure E)

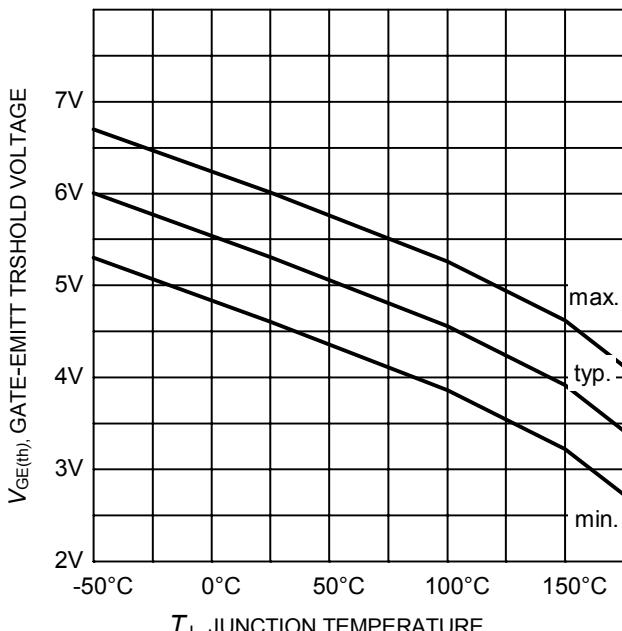


Figure 12. Gate-emitter threshold voltage as a function of junction temperature
($I_C = 0.3\text{mA}$)

Soft Switching Series

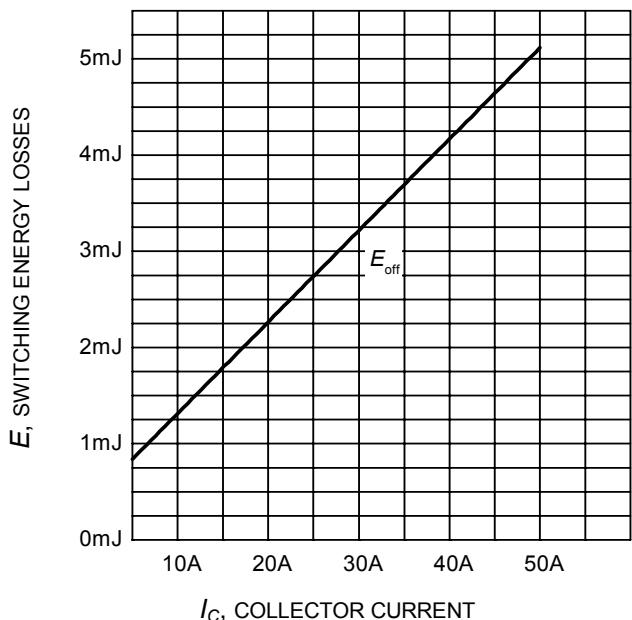


Figure 13. Typical switching energy losses as a function of collector current
 (inductive load, $T_J=175^\circ\text{C}$,
 $V_{CE}=600\text{V}$, $V_{GE}=0/15\text{V}$, $R_G=15\Omega$,
 Dynamic test circuit in Figure E)

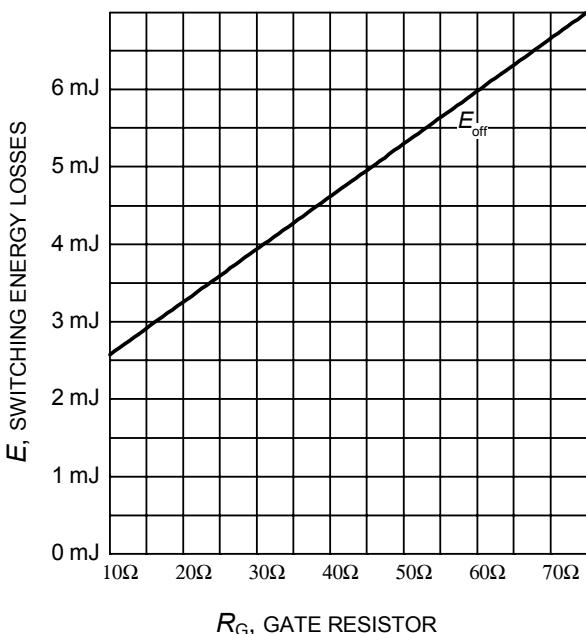


Figure 14. Typical switching energy losses as a function of gate resistor
 (inductive load, $T_J=175^\circ\text{C}$,
 $V_{CE}=600\text{V}$, $V_{GE}=0/15\text{V}$, $I_C=30\text{A}$,
 Dynamic test circuit in Figure E)

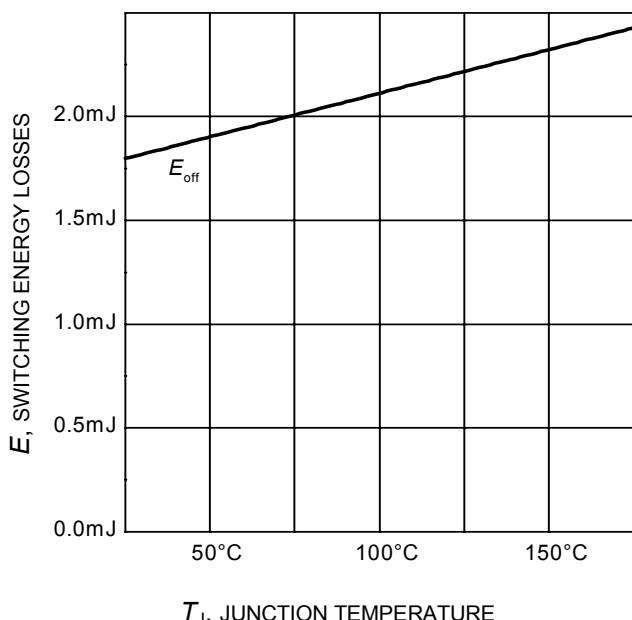


Figure 15. Typical switching energy losses as a function of junction temperature
 (inductive load, $V_{CE}=600\text{V}$,
 $V_{GE}=0/15\text{V}$, $I_C=30\text{A}$, $R_G=15\Omega$,
 Dynamic test circuit in Figure E)

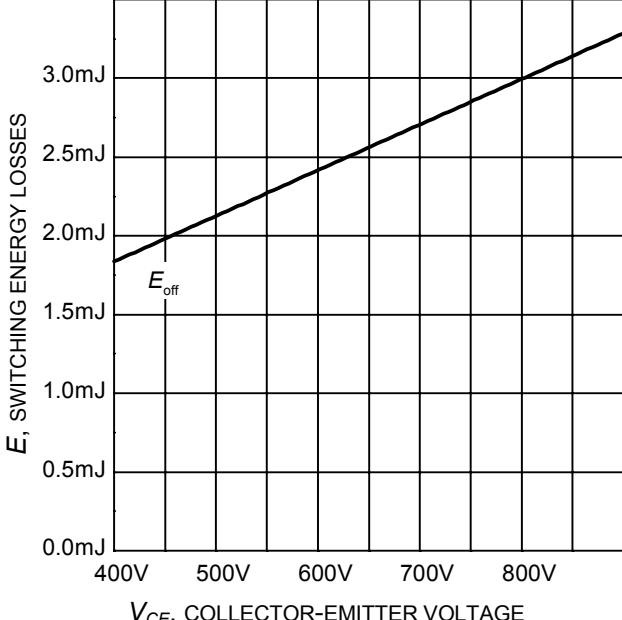


Figure 16. Typical switching energy losses as a function of collector emitter voltage
 (inductive load, $T_J=175^\circ\text{C}$,
 $V_{GE}=0/15\text{V}$, $I_C=30\text{A}$, $R_G=15\Omega$,
 Dynamic test circuit in Figure E)

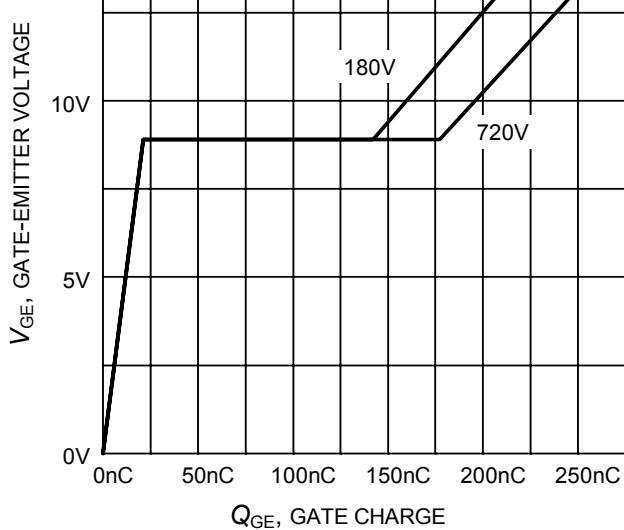


Figure 17. Typical gate charge
($I_C=30$ A)

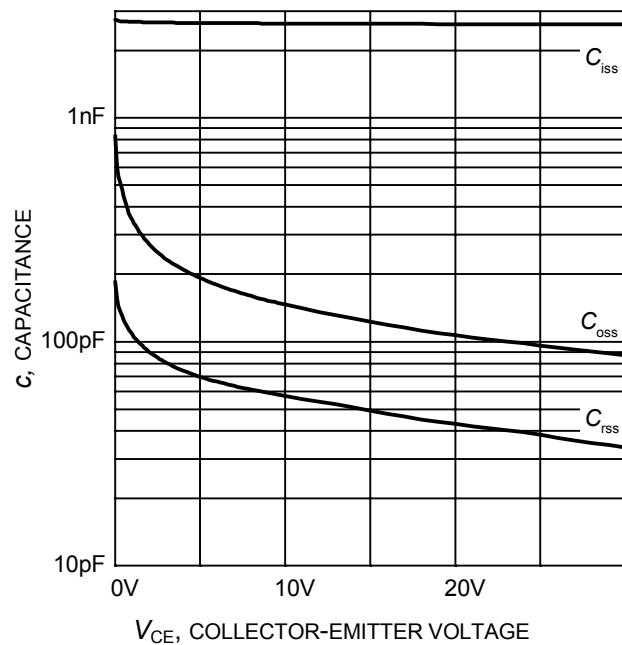


Figure 18. Typical capacitance as a function of collector-emitter voltage
($V_{GE}=0$ V, $f = 1$ MHz)

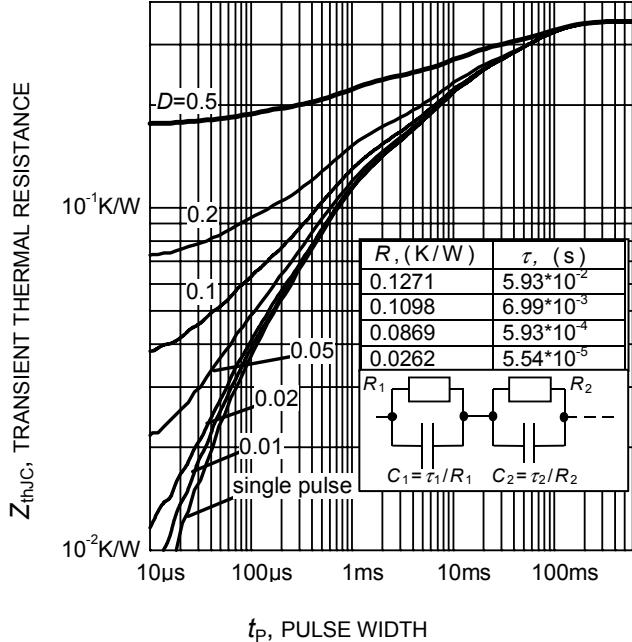


Figure 19. IGBT transient thermal resistance
($D = t_p / T$)

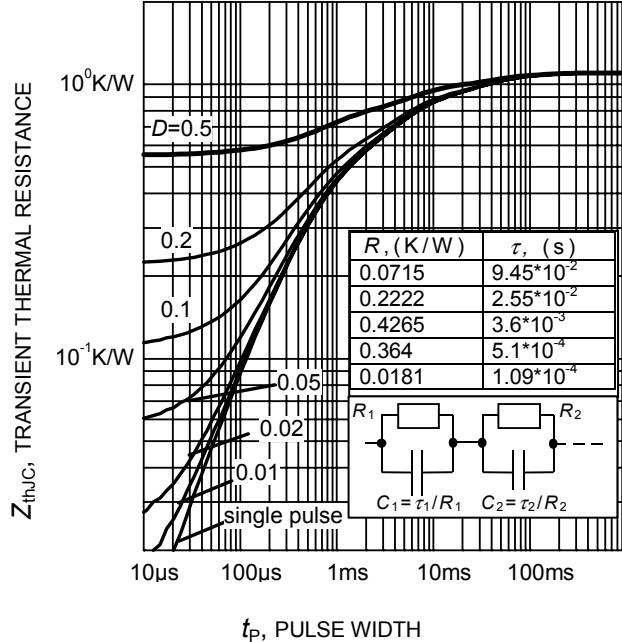


Figure 20. Typical Diode transient thermal impedance as a function of pulse width
($D=t_p/T$)

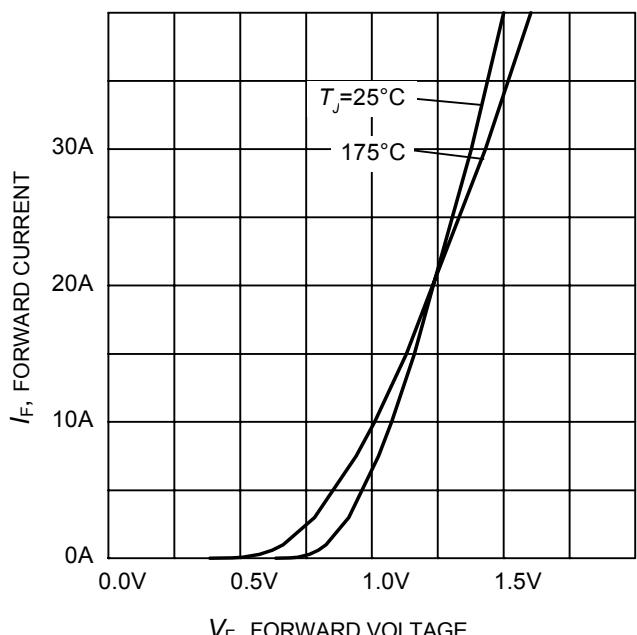


Figure 21. Typical diode forward current as a function of forward voltage

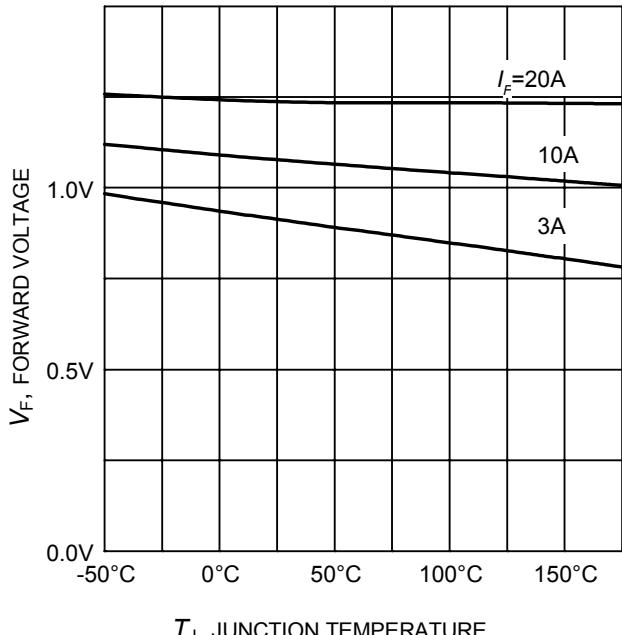
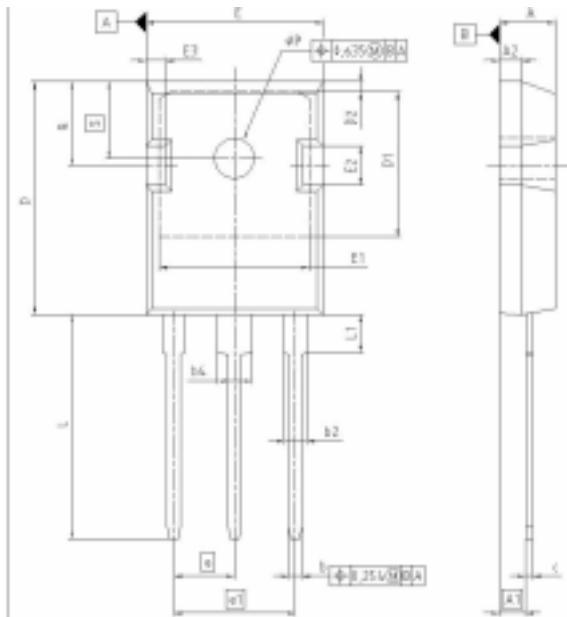


Figure 22. Typical diode forward voltage as a function of junction temperature

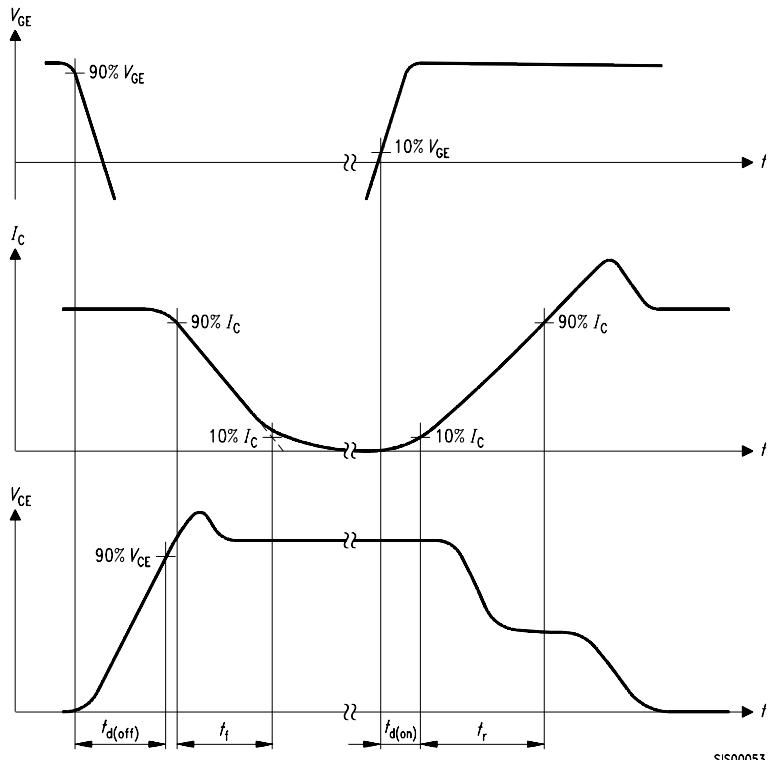
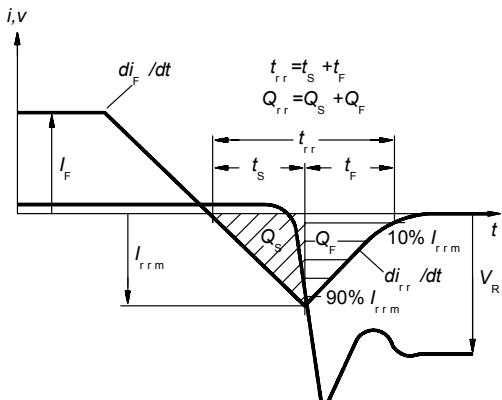
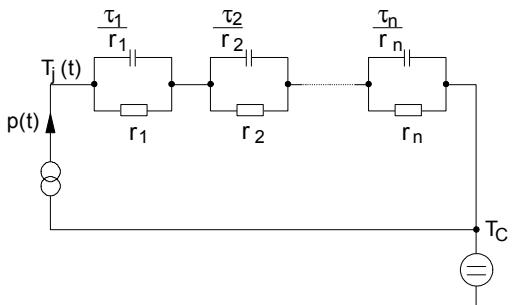
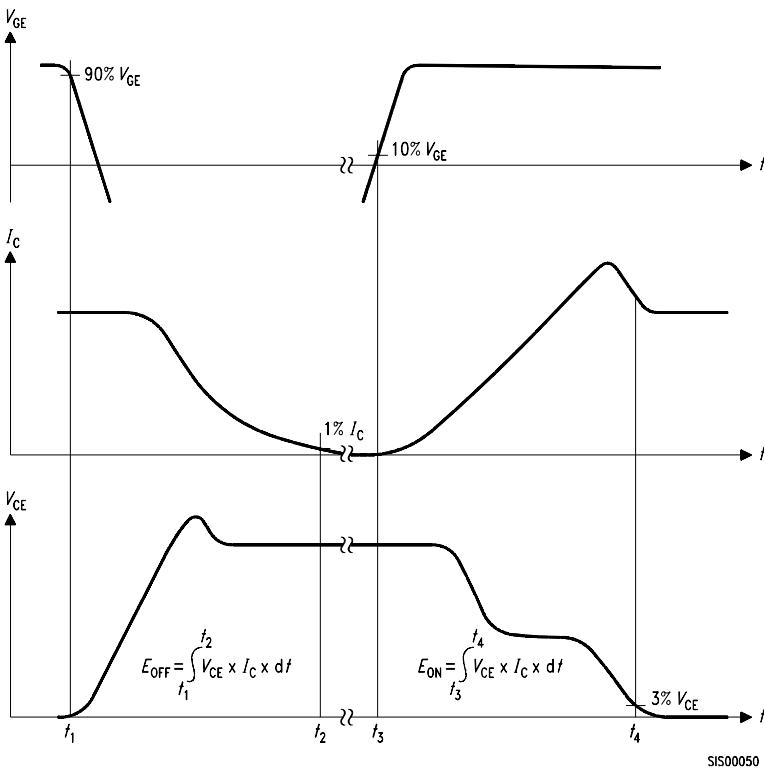


PG-T0247-3-21



DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	4.905	5.157	0.193	0.203
A1	2.273	2.527	0.092	0.098
A2	1.853	2.107	0.073	0.081
b	1.073	1.327	0.042	0.052
b2	1.903	2.306	0.075	0.094
b4	2.970	3.454	0.113	0.138
c	0.549	0.752	0.021	0.030
D	29.823	21.077	0.820	0.830
D1	17.323	17.631	0.682	0.702
D2	8.083	13.317	0.322	0.522
E	15.773	16.027	0.614	0.634
E1	13.893	14.847	0.547	0.587
E2	3.883	3.907	0.145	0.155
E3	1.663	1.937	0.065	0.075
E4		5.450		0.215
e1		10.900		0.430
N		3		3
L	29.053	29.307	0.799	0.799
L1	4.166	4.472	0.164	0.178
eP	3.558	3.661	0.140	0.144
Q	5.493	5.747	0.219	0.228
S	6.913	6.297	0.238	0.248

Soft Switching Series

**Figure A. Definition of switching times****Figure C. Definition of diodes switching characteristics****Figure D. Thermal equivalent circuit****Figure B. Definition of switching losses**



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